

Flash Microcontroller Programming Specification

1.0 DEVICE OVERVIEW

This document includes the programming specifications for the following devices:

- PIC18F66J60 PIC18F66J65 PIC18F67J60
- PIC18F86J60 PIC18F86J65 PIC18F87J60
- PIC18F96J60
 PIC18F96J65
 PIC18F97J60

2.0 PROGRAMMING OVERVIEW OF THE PIC18F97J60 FAMILY

The PIC18F97J60 family devices are programmed using In-Circuit Serial Programming[™] (ICSP[™]). This programming specification applies to devices of the PIC18F97J60 family in all package types.

2.1 Pin Diagrams

The pin diagrams for the PIC18F97J60 family are shown in Figure 2-1 through Figure 2-3. The pins that are required for programming are listed in Table 2-1 and shown in darker lettering in the figures.

TABLE 2-1: PIN DESCRIPTIONS (DURING PROGRAMMING): PIC18F97J60 FAMILY

Pin Name	During Programming		
Pin Name	Pin Name	Pin Type	Pin Description
MCLR	MCLR	Р	Programming Enable
VDD and AVDD ⁽¹⁾	VDD	Р	Power Supply
Vss and AVss ⁽¹⁾	Vss	Р	Ground
ENVREG	ENVREG	Р	Internal Voltage Regulator Enable
VDDCORE/VCAP	VDDCORE	RE P Regulated Power Supply for Microcontroller Core	
	VCAP	I	Filter Capacitor for On-Chip Voltage Regulator
RB6	PGC	I	Serial Clock
RB7	PGD I/O Serial Data		Serial Data

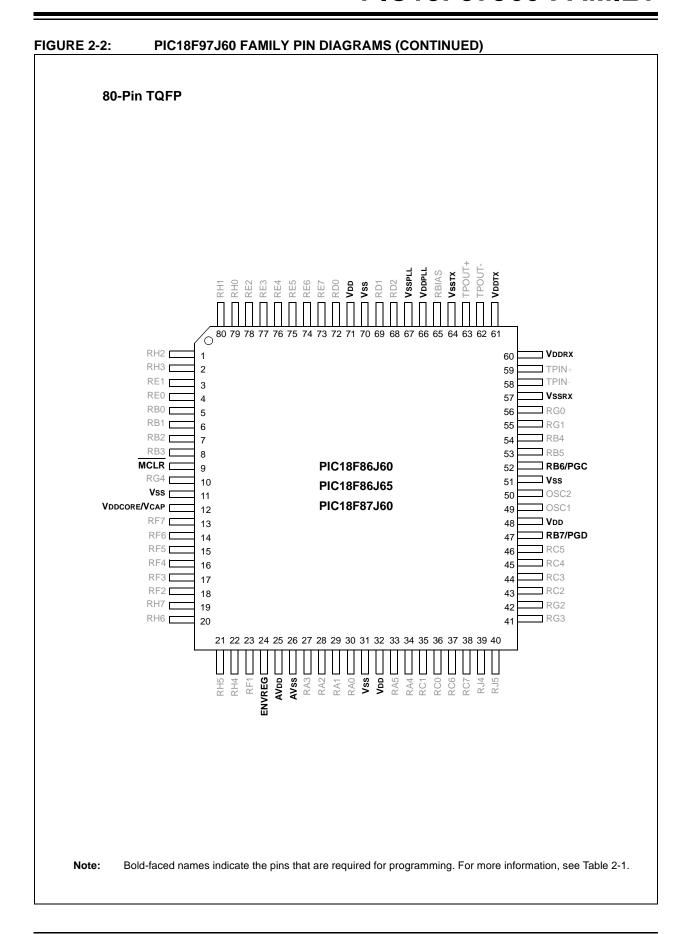
Legend: I = Input, O = Output, P = Power

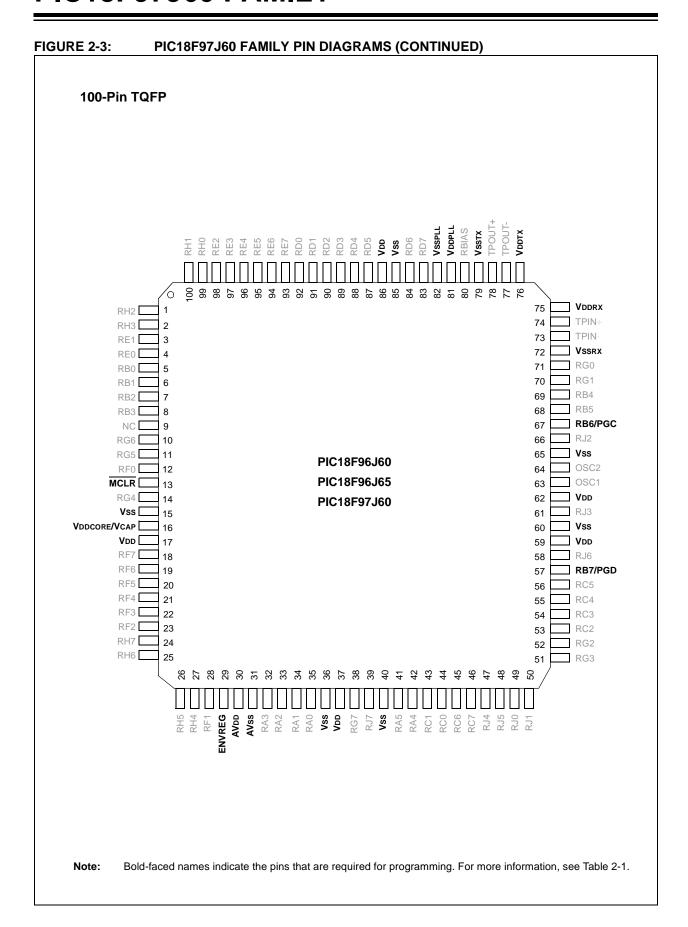
Note 1: All power supply and ground pins must be connected, including analog and Ethernet supplies (AVDD, VDDPLL, VDDRX, VDDTX) and grounds (AVSS, VSSPLL, VSSRX, VSSTX).

FIGURE 2-1: PIC18F97J60 FAMILY PIN DIAGRAMS 64-Pin TQFP 64 63 62 61 60 59 58 57 56 55 54 53 52 51 50 49 0 RE1 **V**DDRX 48 RE0 TPIN-47 TPIN-3 RB1 Vssrx RB2 RB4 5 44 RB3 RB5 6 43 MCLR RB6/PGC PIC18F66J60 42 Vss 8 41 PIC18F66J65 OSC2 40 PIC18F67J60 VDDCORE/VCAP OSC1 39 \mathbf{V}_{DD} 38 RB7/PGD 12 37 RC5 13 36 RC4 35 14 RC3 15 34 RC2 16

Bold-faced names indicate the pins that are required for programming. For more information, see Table 2-1.

Note:





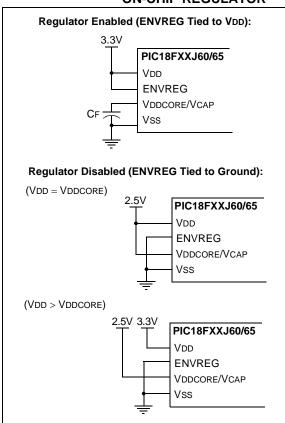
2.1.1 ON-CHIP VOLTAGE REGULATOR

The microcontroller core of PIC18F97J60 family devices can be powered either from an external source, or from an on-chip regulator, which derives power from VDD. Both sources use the common VDDCORE/VCAP pin.

The regulator is enabled by connecting VDD to the ENVREG pin. In this case, a low-ESR capacitor must be connected to the VDDCORE/VCAP pin for proper device operation. If the regulator is disabled, power to the core must be supplied on VDDCORE/VCAP. Where VDD exceeds VDDCOREMAX, power to the core must be supplied separately on VDDCORE/VCAP. Examples are shown in Figure 2-4. Whether or not the regulator is used, it is always good design practice to have sufficient capacitance on all supply pins.

The specifications for core voltage and capacitance are listed in Section 6.0 "AC/DC Characteristics and Timing Requirements".

FIGURE 2-4: CONNECTIONS FOR THE ON-CHIP REGULATOR



2.2 Memory Maps

PIC18F97J60 family devices are available in three program memory sizes: 64 Kbytes, 96 Kbytes and 128 Kbytes. The overall memory maps for all devices are shown in Figure 2-5.

For purposes of code protection, the program memory for every device is treated as a single block. Enabling code protection thus protects the entire code memory and not individual segments.

The Configuration Words for these devices are located at addresses 300000h through 300005h. These are implemented as three pairs of volatile memory registers. Each register is automatically loaded from a copy stored at the end of program memory. For this reason, the last four words of the code space (also called the Flash Configuration Words) should be written with configuration data and not executable code. The addresses of the Flash Configuration Words are also listed in Table 2-2. Refer to **Section 5.0** "Configuration Word" for more information.

Locations 3FFFFEh and 3FFFFFh are reserved for the device ID bits. These bits may be used by the programmer to identify what device type is being programmed and are described in **Section 5.1 "Device ID Word"**. These device ID bits read out normally, even after code protection.

TABLE 2-2: PROGRAM MEMORY SIZES FOR PIC18F97J60 FAMILY DEVICES

==::==				
Device	Program Memory (Kbytes)	Location of Flash Configuration Words		
PIC18F66J60				
PIC18F86J60	64	FFF8h:FFFFh		
PIC18F96J60				
PIC18F66J65				
PIC18F86J65	96	17FF8h:17FFFh		
PIC18F96J65				
PIC18F67J60				
PIC18F87J60	128	1FFF8h:1FFFFh		
PIC18F97J60				

2.2.1 MEMORY ADDRESS POINTER

Memory in the device address space (000000h to 3FFFFFh) is addressed via the Table Pointer register, which in turn is comprised of three registers:

- TBLPTRU at RAM address 0FF8h
- TBLPTRH at RAM address 0FF7h
- · TBLPTRL at RAM address 0FF6h

TBLPTRU	TBLPTRH	TBLPTRL
Addr[21:16]	Addr[15:8]	Addr[7:0]

The 4-bit command, '0000' (core instruction), is used to load the Table Pointer prior to using many read or write operations.

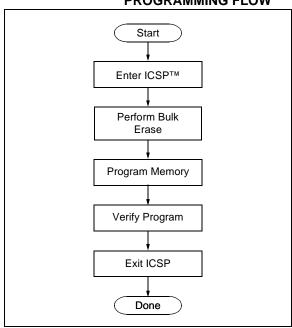
FIGURE 2-5: MEMORY MAPS FOR PIC18F97J60 FAMILY DEVICES

PIC18FX6J60 (64 Kbytes)	PIC18FX6J65 (96 Kbytes)	PIC18FX7J60 (128 Kbytes)	000000	
Code Memory	Code Memory	Code Memory	000000h	
Flash Configuration Words			- 00FFFFh	
	Flash Configuration Words		017FFFh	
			01711111	
Unimplemented Read as '0'		Flash Configuration Words	-01FFFFh	
	Unimplemented			
	Read as '0'	Unimplemented		
		Read as '0'		
			1FFFFFh	
			200000h	
Configuration	Configuration	Configuration		
Space	Space	Space		
			2FFFFFh	
Configuration Words	Configuration Words	Configuration Words	300000h 300005h	
			30000311	
Configuration Space	Configuration Space	Configuration Space		
ориос	ορασσ	Opass		
			3FFFFEh	
Device IDs	Device IDs	Device IDs	3FFFFFh	
	nented or unavailable in normal exe		otion Morel-	
Memory spaces are read-only (Device IDs) or cannot be directly programmed by ICSP™ (Configuration Words). ote: Sizes of memory areas are not to scale. Sizes of accessible memory areas are enhanced to show detail.				
ote: Sizes of memory areas are	e not to scale. Sizes of accessible n	nemory areas are ennanced to st	iow detail.	

2.3 Overview of the Programming Process

Figure 2-6 shows the high-level overview of the programming process. First, a Bulk Erase is performed. Next, the code memory is programmed. Since the only nonvolatile Configuration Words are within the code memory space, they too are programmed as if they were code. Code memory (including the Configuration Words) is then verified to ensure that programming was successful.

FIGURE 2-6: HIGH-LEVEL PROGRAMMING FLOW



2.4 Entering and Exiting ICSP Program/Verify Mode

Entry into ICSP modes for PIC18F97J60 family devices is somewhat different than previous PIC18 devices. As shown in Figure 2-7, entering ICSP Program/Verify mode requires three steps:

- Voltage is briefly applied to the MCLR pin.
- 2. A 32-bit key sequence is presented on PGD.
- Voltage is reapplied to MCLR and held.

The programming voltage applied to $\overline{\text{MCLR}}$ is VIH, or usually, VDD. There is no minimum time requirement for holding at VIH. After VIH is removed, an interval of at least P19 must elapse before presenting the key sequence on PGD.

The key sequence is a specific 32-bit pattern, '0100 1101 0100 0011 0100 1000 0101 0000' (more easily remembered as 4D434850h in hexadecimal). The device will enter Program/Verify mode only if the sequence is valid. The Most Significant bit of the most significant nibble must be shifted in first.

Once the key sequence is complete, VIH must be applied to MCLR and held at that level for as long as Program/Verify mode is to be maintained. An interval of at least time P20 and P12 must elapse before presenting data on PGD. Signals appearing on PGD before P12 has elapsed may not be interpreted as valid.

On successful entry, the program memory can be accessed and programmed in serial fashion. While in the Program/Verify mode, all unused I/Os are placed in the high-impedance state.

Exiting Program/Verify mode is done by removing VIH from MCLR, as shown in Figure 2-8. The only requirement for exit is that an interval, P16, should elapse between the last clock and program signals on PGC and PGD before removing VIH.

When VIH is reapplied to $\overline{\text{MCLR}}$, the device will enter the ordinary operational mode and begin executing the application instructions.

FIGURE 2-7: ENTERING PROGRAM/VERIFY MODE

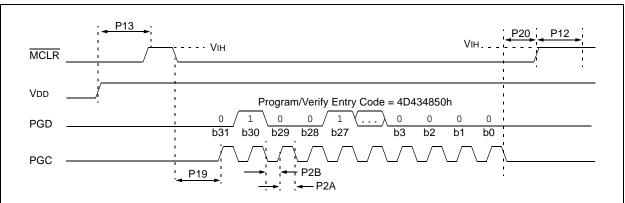
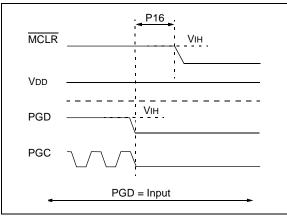


FIGURE 2-8: EXITING PROGRAM/ VERIFY MODE



2.5 Serial Program/Verify Operation

The PGC pin is used as a clock input pin and the PGD pin is used for entering command bits and data input/output during serial operation. Commands and data are transmitted on the rising edge of PGC, latched on the falling edge of PGC and are Least Significant bit (LSb) first.

2.5.1 4-BIT COMMANDS

All instructions are 20 bits, consisting of a leading 4-bit command, followed by a 16-bit operand, which depends on the type of command being executed. To input a command, PGC is cycled four times. The commands needed for programming and verification are shown in Table 2-3.

Depending on the 4-bit command, the 16-bit operand represents 16 bits of input data or 8 bits of input data and 8 bits of output data.

Throughout this specification, commands and data are presented as illustrated in Table 2-4. The 4-bit command is shown Most Significant bit (MSb) first. The command operand, or "Data Payload", is shown <MSB><LSB>. Figure 2-9 demonstrates how to serially present a 20-bit command/operand to the device.

2.5.2 CORE INSTRUCTION

The core instruction passes a 16-bit instruction to the CPU core for execution. This is needed to set up registers as appropriate for use with other commands.

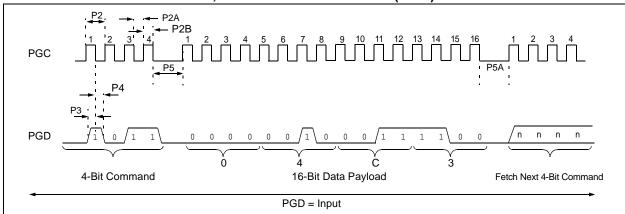
TABLE 2-3: COMMANDS FOR PROGRAMMING

Description	4-Bit Command
Core Instruction (Shift in 16-bit instruction)	0000
Shift Out TABLAT Register	0010
Table Read	1000
Table Read, Post-Increment	1001
Table Read, Post-Decrement	1010
Table Read, Pre-Increment	1011
Table Write	1100
Table Write, Post-Increment by 2	1101
Table Write, Start Programming, Post-Increment by 2	1110
Table Write, Start Programming	1111

TABLE 2-4: SAMPLE COMMAND SEQUENCE

4-Bit Command	Data Payload	Core Instruction
1101	3C 40	Table Write, post-increment by 2

FIGURE 2-9: TABLE WRITE, POST-INCREMENT TIMING (1101)



3.0 DEVICE PROGRAMMING

Programming includes the ability to erase or write the memory within the device.

The EECON1 register is used to control write or row erase operations. The WREN bit must be set to enable writes; this must be done prior to initiating a write sequence. It is strongly recommended that the WREN bit only be set immediately prior to a program or erase operation.

The FREE bit must be set in order to erase the program space being pointed to by the Table Pointer. The erase or write sequence is initiated by setting the WR bit.

3.1 ICSP Erase

3.1.1 ICSP BULK ERASE

Devices of the PIC18F97J60 family may be Bulk Erased by writing 0180h to the table address 3C0005h:3C0004h. The basic sequence is shown in Figure 3-1 and demonstrated in Table 3-1.

Since the code-protect Configuration bit is stored in the program code within code memory, a Bulk Erase operation will also clear any code-protect settings for the device.

The actual Bulk Erase function is a self-timed operation. Once the erase has started (falling edge of the 4th PGC after the NOP command), serial execution will cease until the erase completes (parameter P11). During this time, PGC may continue to toggle but PGD must be held low.

Note: A Bulk Erase is the only way to reprogram the code-protect Configuration bit from an ON state to an OFF state.

TABLE 3-1: BULK ERASE COMMAND SEQUENCE

4-Bit Command	Data Payload	Core Instruction	
0000	0E 3C	MOVLW 3Ch	
0000	6E F8	MOVWF TBLPTRU	
0000	0E 00	MOVLW 00h	
0000	6E F7	MOVWF TBLPTRH	
0000	0E 05	MOVLW 05h	
0000	6E F6	MOVWF TBLPTRL	
1100	01 01	Write 01h to 3C0005h	
0000	0E 3C	MOVLW 3Ch	
0000	6E F8	MOVWF TBLPTRU	
0000	0E 00	MOVLW 00h	
0000	6E F7	MOVWF TBLPTRH	
0000	0E 04	MOVLW 04h	
0000	6E F6	MOVWF TBLPTRL	
1100	80 80	Write 80h TO 3C0004h to	
		erase entire device.	
		NOP	
0000	00 00	Hold PGD low until erase	
0000	00 00	completes.	

FIGURE 3-1: BULK ERASE FLOW

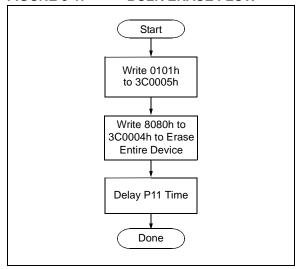
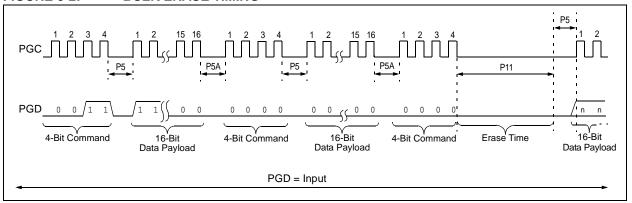


FIGURE 3-2: BULK ERASE TIMING



3.1.2 ICSP ROW ERASE

It is possible to erase a single row (1024 bytes of data), provided the block is not code-protected. Rows are located at static boundaries beginning at program memory address 000000h, extending to the internal program memory limit (see **Section 2.2 "Memory Maps"**).

The Row Erase duration is internally timed. After the WR bit in EECON1 is set, a \mathtt{NOP} is issued, where the 4th PGC is held high for the duration of the Row Erase time, P10.

The code sequence to Row Erase a PIC18F97J60 family device is shown in Table 3-2. The flowchart shown in Figure 3-3 depicts the logic necessary to completely erase a PIC18F97J60 family device. The timing diagram that details the "Row Erase" operation and parameter P10 is shown in Figure 3-4.

Note: The TBLPTR register can point at any byte within the row intended for erase.

FIGURE 3-3: ROW ERASE CODE MEMORY FLOW

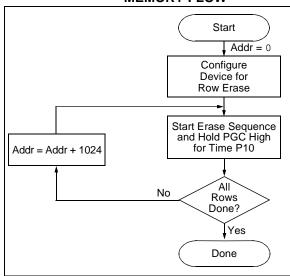
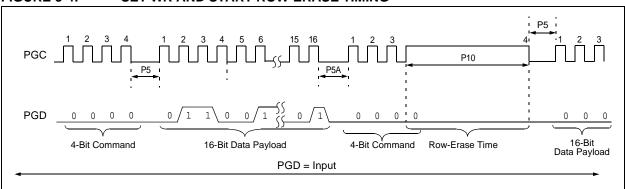


TABLE 3-2: ERASE CODE MEMORY CODE SEQUENCE

4-Bit Command	Data Payload	Core Instruction	
Step 1: Enable me	emory writes.		
0000	84 A6	BSF EECON1, WREN	
Step 2: Point to fir	st row in code memory.		
0000 0000 0000	6A F8 6A F7 6A F6	CLRF TBLPTRU CLRF TBLPTRH CLRF TBLPTRL	
Step 3: Enable era	Step 3: Enable erase and erase single row.		
0000 0000 0000	88 A6 82 A6 00 00	BSF EECON1, FREE BSF EECON1, WR NOP - hold PGC high for time P10.	
Step 4: Repeat st	Step 4: Repeat step 3, with Address Pointer incremented by 1024 until all rows are erased.		

FIGURE 3-4: SET WR AND START ROW-ERASE TIMING



3.2 Code Memory Programming

Programming code memory is accomplished by first loading data into the write buffer and then initiating a programming sequence. The write buffer for all devices in the PIC18F97J60 family is 64 bytes; it can be mapped to any integral boundary of 64 bytes, beginning at 000000h. The actual memory write sequence takes the contents of this buffer and programs the 64 bytes of code memory that contains the Table Pointer.

Write buffer locations are not cleared following a write operation; the buffer retains its data after the write is complete. This means that the buffer must be written with 64 bytes on each operation. If there are locations in the code memory that are to remain empty, the corresponding locations in the buffer must be filled with FFFFh. This avoids rewriting old data from the previous cycle.

The programming duration is internally timed. After a Start Programming command is issued (4-bit command, '1111'), a NOP is issued, where the 4th PGC is held high for the duration of the programming time, P9.

The code sequence to program a PIC18F97J60 family device is shown in Table 3-3. The flowchart shown in Figure 3-5 depicts the logic necessary to completely write a PIC18F97J60 family device. The timing diagram that details the Start Programming command and parameter P9 is shown in Figure 3-6.

- Note 1: To maintain the endurance specification of the Flash program memory cells, each 64-byte block of program memory should never be programmed more than once between erase operations. If any byte within a 64-byte block of program memory is written, that entire block must not be written to again until a Bulk Erase on the part, or a Row Erase on the row containing the modified 64-byte block, has been performed.
 - 2: The TBLPTR register must point to the same region when initiating the programming sequence as it did when the write buffers were loaded.

TABLE 3-3: WRITE CODE MEMORY CODE SEQUENCE

4-Bit Command	Data Payload	Core Instruction	
Step 1: Enable w	vrites.		
0000	84 A6	BSF EECON1, WREN	
Step 2: Load writ	te buffer.		
0000 0000 0000 0000 0000	OE <addr[21:16]> 6E F8 OE <addr[15:8]> 6E F7 OE <addr[7:0]> 6E F6</addr[7:0]></addr[15:8]></addr[21:16]>	MOVLW <addr[21:16]> MOVWF TBLPTRU MOVLW <addr[15:8]> MOVWF TBLPTRH MOVLW <addr[7:0]> MOVWF TBLPTRL</addr[7:0]></addr[15:8]></addr[21:16]>	
Step 3: Repeat for	Step 3: Repeat for all but the last two bytes. Any unused locations should be filled with FFFFh.		
1101	<msb><lsb></lsb></msb>	Write 2 bytes and post-increment address by 2.	
Step 4: Load writ	Step 4: Load write buffer for last two bytes.		
1111 0000	<msb><lsb></lsb></msb>	Write 2 bytes and start programming. NOP - hold PGC high for time P9.	
To continue writing data, repeat steps 2 through 4, where the Address Pointer is incremented by 2 at each iteration of the loop.			

FIGURE 3-5: PROGRAM CODE MEMORY FLOW

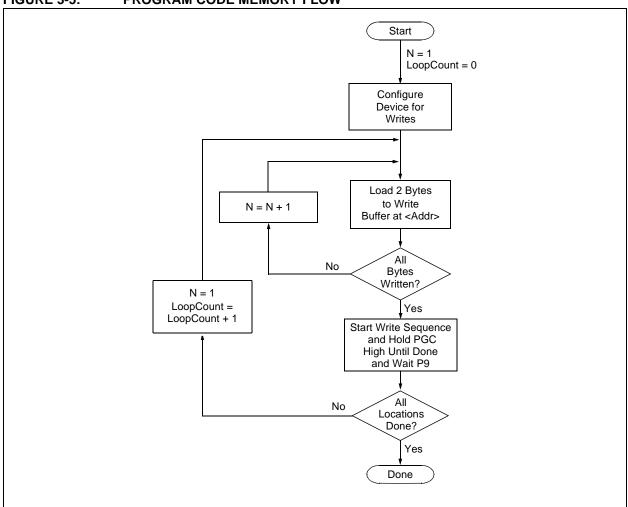
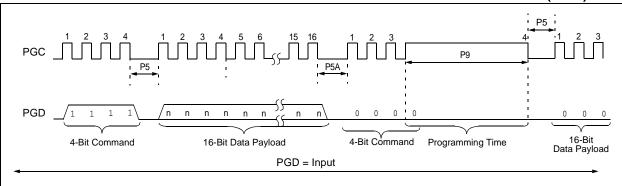


FIGURE 3-6: TABLE WRITE AND START PROGRAMMING INSTRUCTION TIMING (1111)



3.2.1 MODIFYING CODE MEMORY

The previous programming example assumed that the device had been Bulk Erased prior to programming. It may be the case, however, that the user wishes to modify only a section of an already programmed device.

The appropriate number of bytes required for the erase buffer (1,024 bytes) must be read out of code memory (as described in **Section 4.2 "Verify Code Memory and Configuration Word"**) and buffered. Modifications can be made on this buffer. Then, the row of code memory that was read out must be erased and rewritten with the modified data. The code sequence is shown in Table 3-4.

The WREN bit must be set if the WR bit in EECON1 is used to initiate a write sequence.

3.2.2 CONFIGURATION WORD PROGRAMMING

Since the Flash Configuration Words are stored in program memory, they are programmed as if they were program data. Refer to Section 3.2 "Code Memory Programming" and Section 3.2.1 "Modifying Code Memory" for methods and examples on programming or modifying program memory. See also Section 5.0 "Configuration Word" for additional information on the Configuration Words.

TABLE 3-4: MODIFYING CODE MEMORY

TABLE 3-4:	MODIFYING CODE MEMORY		
4-Bit Command	Data Payload	Core Instruction	
Step 1: Set the Ta	able Pointer for the block to b	pe erased.	
0000 0000 0000 0000 0000	0E <addr[21:16]> 6E F8 0E <addr[8:15]> 6E F7 0E <addr[7:0]> 6E F6</addr[7:0]></addr[8:15]></addr[21:16]>	MOVLW <addr[21:16]> MOVWF TBLPTRU MOVLW <addr[8:15]> MOVWF TBLPTRH MOVLW <addr[7:0]> MOVWF TBLPTRL</addr[7:0]></addr[8:15]></addr[21:16]>	
Step 2: Enable m	emory writes and set up an e	erase.	
0000	84 A6 88 A6	BSF EECON1, WREN BSF EECON1, FREE	
Step 3: Initiate era	ase.		
0000	82 A6 00 00	BSF EECON1, WR NOP - hold PGC high for time P10.	
Step 4: Load write	e buffer. The correct bytes w	ill be selected based on the Table Pointer.	
0000 0000 0000 0000 0000 0000 1101 	<pre>0E <addr[21:16]> 6E F8 0E <addr[8:15]> 6E F7 0E <addr[7:0]> 6E F6 <msb><lsb></lsb></msb></addr[7:0]></addr[8:15]></addr[21:16]></pre>	MOVLW <addr[21:16]> MOVWF TBLPTRU MOVLW <addr[8:15]> MOVWF TBLPTRH MOVLW <addr[7:0]> MOVWF TBLPTRL Write 2 bytes and post-increment address by 2. Repeat write operation 30 more times to fill the write buffer Write 2 bytes and start programming. NOP - hold PGC high for time P9.</addr[7:0]></addr[8:15]></addr[21:16]>	
<u> </u>	• •	to completely rewrite the 1024 bytes of the erase buffer.	
•	Step 6: To continue modifying data, repeat Steps 1 through 4, where the Address Pointer is incremented by 1024 bytes at each iteration of the loop.		
Step 7: Disable w	rites.		
0000	94 A6	BCF EECON1, WREN	

4.0 READING THE DEVICE

4.1 Read Code Memory

Code memory is accessed one byte at a time via the 4-bit command, '1001' (table read, post-increment). The contents of memory pointed to by the Table Pointer (TBLPTRU:TBLPTRH:TBLPTRL) are serially output on PGD.

The 4-bit command is shifted in LSb first. The read is executed during the next 8 clocks, then shifted out on PGD during the last 8 clocks, LSb to MSb. A delay of

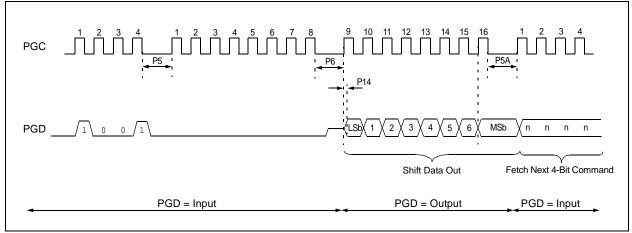
P6 must be introduced after the falling edge of the 8th PGC of the operand to allow PGD to transition from an input to an output. During this time, PGC must be held low (see Figure 4-1). This operation also increments the Table Pointer by one, pointing to the next byte in code memory for the next read.

This technique will work to read any memory in the 000000h to 3FFFFFh address space, so it also applies to the reading of the Configuration registers.

TABLE 4-1: READ CODE MEMORY SEQUENCE

4-Bit Command	Data Payload	Core Instruction	
Step 1: Set Table	Pointer.		
0000 0000 0000 0000 0000	OE <addr[21:16]> 6E F8 OE <addr[15:8]> 6E F7 OE <addr[7:0]> 6E F6</addr[7:0]></addr[15:8]></addr[21:16]>	MOVLW Addr[21:16] MOVWF TBLPTRU MOVLW <addr[15:8]> MOVWF TBLPTRH MOVLW <addr[7:0]> MOVWF TBLPTRL</addr[7:0]></addr[15:8]>	
Step 2: Read memory and then shift out on PGD, LSb to MSb.			
1001	00 00	TBLRD *+	





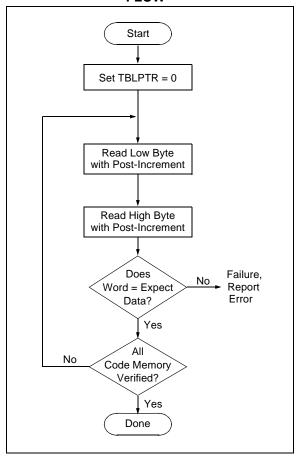
4.2 Verify Code Memory and Configuration Word

The verify step involves reading back the code memory space and comparing it against the copy held in the programmer's buffer. Because the Flash Configuration Words are stored at the end of program memory, it is verified with the rest of the code at this time.

The verify process is shown in the flowchart in Figure 4-2. Memory reads occur a single byte at a time, so two bytes must be read to compare against the word in the programmer's buffer. Refer to **Section 4.1** "**Read Code Memory**" for implementation details of reading code memory.

Note: Because the Flash Configuration Word contains the device code protection bit, code memory should be verified immediately after writing if code protection is enabled. This is because the device will not be readable or verifiable if a device Reset occurs after the Flash Configuration Words (and the CP0 bit) have been cleared.

FIGURE 4-2: VERIFY CODE MEMORY FLOW



4.3 Blank Check

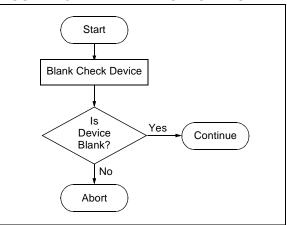
The term "Blank Check" means to verify that the device has no programmed memory cells. All memories must be verified: code memory and Configuration bits. The Device ID registers (3FFFFEh:3FFFFh) should be ignored.

A "blank" or "erased" memory cell will read as a '1'. So, Blank Checking a device merely means to verify that all bytes read as FFh. The overall process flow is shown in Figure 4-3.

Note: Following a device Bulk Erase, the Configuration Words will read as shown in Table 5-2.

Given that Blank Checking is merely code verification with FFh expect data, refer to Section 4.2 "Verify Code Memory and Configuration Word" for implementation details.

FIGURE 4-3: BLANK CHECK FLOW



5.0 CONFIGURATION WORD

The Configuration Words of the PIC18F97J60 family devices are implemented as volatile memory registers, as opposed to the programmable nonvolatile memory used in other PIC18 devices. All of the Configuration registers (CONFIG1L, CONFIG1H, CONFIG2L, CONFIG2H, CONFIG3L and CONFIG3H) are automatically loaded following each device Reset.

The data for these registers is taken from the four Flash Configuration Words located at the end of program memory. Configuration data is stored in order, starting with CONFIG1L in the lowest Flash address and ending with CONFIG4H in the last address. The mapping to specific Configuration Words is shown in Table 5-1. While four words are reserved in program memory, only three words (CONFIG1L through CONFIG3H) are used for device configuration. Users should always reserve these locations for Configuration Word data and write their application code accordingly.

The upper four bits of each Configuration Word should always be stored in program memory as '1111'. This is done so these program memory addresses will always be '1111 xxxx xxxx xxxx' and interpreted as a NOP instruction if they were ever to be executed. Because the corresponding bits in the Configuration Words are unimplemented, they will not change the device's configuration.

The Configuration and Device ID registers are summarized in Table 5-2. A listing of the individual Configuration bits and their options is provided in Table 5-3.

TABLE 5-1: MAPPING OF THE FLASH
CONFIGURATION WORDS TO
THE CONFIGURATION
REGISTERS

Configuration Byte	Code Space Address ⁽¹⁾	Configuration Register Address
CONFIG1L	XXXF8h	300000h
CONFIG1H	XXXF9h	300001h
CONFIG2L	XXXFAh	300002h
CONFIG2H	XXXFBh	300003h
CONFIG3L	XXXFCh	300004h
CONFIG3H	XXXFDh	300005h
CONFIG4L ⁽²⁾	XXXFEh	300006h
CONFIG4H ⁽²⁾	XXXFFh	300007h

- **Note 1:** See Table 2-2 for the complete addresses within code space for specific devices and memory sizes.
 - 2: Unimplemented in PIC18F97J60 family devices.

TABLE 5-2: CONFIGURATION BITS AND DEVICE IDS

File Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value
300000h	CONFIG1L	DEBUG	XINST	STVREN	_	_	_	_	WDTEN	1111
300001h	CONFIG1H	(1)	(1)	(1)	(1)	(2)	CP0	_	_	01
300002h	CONFIG2L	IESO	FCMEN		_	_	FOSC2	FOSC1	FOSC0	11111
300003h	CONFIG2H	(1)	(1)	(1)	(1)	WDTPS3	WDTPS2	WDTPS1	WDTPS0	1111
300004h	CONFIG3L	WAIT ⁽³⁾	BW ⁽³⁾	EMB1 ⁽³⁾	EMB0 ⁽³⁾	EASHFT(3)	_	_	_	1111 1
300005h	CONFIG3H	(1)	(1)	(1)	(1)	_	ETHLED	ECCPMX ⁽⁴⁾	CCP2MX ⁽⁴⁾	111
3FFFFEh	DEVID1 ⁽⁵⁾	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	See Table 5-4
3FFFFFh	DEVID2 ⁽⁵⁾	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	See Table 5-4

Legend: x = unknown, u = unchanged, - = unimplemented, <math>q = value depends on condition. Shaded cells are unimplemented, read as '0'.

- Note 1: The value of these bits in program memory should always be '1'. This ensures that the location is executed as a NOP if it is accidentally executed.
 - 2: This bit should always be maintained as '0'.
 - 3: Implemented in 100-pin devices only.
 - 4: Implemented in 80-pin and 100-pin devices only. This bit should always be maintained as '1' for 64-pin devices.
 - 5: DEVID registers are read-only and cannot be programmed by the user.

TABLE 5-3: PIC18F97J60 FAMILY BIT DESCRIPTIONS

Bit Name	Configuration Words	Description
DEBUG	CONFIG1L	Background Debugger Enable bit 1 = Background debugger disabled, RB6 and RB7 configured as general purpose I/O pins 0 = Background debugger enabled, RB6 and RB7 are dedicated to in-circuit debug
XINST	CONFIG1L	Extended Instruction Set Enable bit 1 = Instruction set extension and Indexed Addressing mode enabled 0 = Instruction set extension and Indexed Addressing mode disabled (Legacy mode)
STVREN	CONFIG1L	Stack Overflow/Underflow Reset Enable bit 1 = Reset on stack overflow/underflow enabled 0 = Reset on stack overflow/underflow disabled
WDTEN	CONFIG1L	Watchdog Timer Enable bit 1 = WDT enabled 0 = WDT disabled (control is placed on SWDTEN bit)
CP0	CONFIG1H	Code Protection bit 1 = Program memory is not code-protected 0 = Program memory is code-protected
IESO	CONFIG2L	Internal/External Oscillator Switchover bit 1 = Oscillator Switchover mode enabled 0 = Oscillator Switchover mode disabled
FCMEN	CONFIG2L	Fail-Safe Clock Monitor Enable bit 1 = Fail-Safe Clock Monitor enabled 0 = Fail-Safe Clock Monitor disabled
FOSC2	CONFIG2L	Primary Oscillator Select bit 1 = Default primary oscillator on start-up is EC or HS, depending on settings of FOSC1:FOSC0; INTRC selected when OSCCON<1:0> = 11 0 = Default primary oscillator on start-up is INTRC; INTRC also selected when OSCCON<1:0> = 11 or 00
FOSC1:FOSC0	CONFIG2L	Oscillator Selection bits 11 = EC oscillator, PLL enabled and under software control, CLKO function on OSC2 10 = EC oscillator, CLKO function on OSC2 01 = HS oscillator, PLL enabled and under software control 00 = HS oscillator

TABLE 5-3: PIC18F97J60 FAMILY BIT DESCRIPTIONS (CONTINUED)

TABLE 5-3: PIC18F97J60 FAMILY BIT DESCRIPTIONS (CONTINUED)							
Bit Name	Configuration Words	Description					
WDTPS3:WDTPS0	CONFIG2H	Watchdog Timer Postscale Select bits					
		1111 = 1:32,768					
		1110 = 1:16,384					
		1101 = 1:8,192					
		1100 = 1:4,096					
		1011 = 1:2,048					
		1010 = 1:1,024					
		1001 = 1:512					
		1000 = 1:256					
		0111 = 1:128					
		0110 = 1:64					
		0101 = 1:32					
		0100 = 1:16					
		0011 = 1:8 0010 = 1:4					
		0001 = 1:2					
		0000 = 1:1					
WAIT	CONFICAL	External Bus Wait Enable bit					
VVAII	CONFIG3L						
		1 = Wait states for operations on external memory bus disabled					
		0 = Wait states for operations on external memory bus enabled					
BW	CONFIG3L	Data Bus Width Select bit					
		1 = 16-Bit External Bus mode					
		0 = 8-Bit External Bus mode					
EMB1:EMB0	CONFIG3L	External Memory Bus Configuration bits					
		11 = Microcontroller mode – external bus disabled					
		10 = Extended Microcontroller mode,12-Bit Address mode					
		01 = Extended Microcontroller mode,16-Bit Address mode					
		00 = Extended Microcontroller mode, 20-Bit Address mode					
EASHFT	CONFIG3L	External Address Bus Shift Enable bit					
		1 = Address shifting enabled; address on external bus is offset to start at					
		000000h					
		0 = Address shifting disabled; address on external bus reflects the PC value					
ETHLED	CONFIG3H	Ethernet LED Enable bit					
		1 = RA0/RA1 are multiplexed with LEDA/LEDB when Ethernet module is					
		enabled and function as I/O when Ethernet is disabled					
		0 = RA0/RA1 function as I/O regardless of Ethernet module status					
ECCPMX	CONFIG3H	ECCP MUX bit					
LOOI WIX	CONTIGUIT						
		1 = ECCP1 outputs (P1B/P1C) are multiplexed with RE6 and RE5;					
		ECCP3 outputs (P3B/P3C) are multiplexed with RE4 and RE3 0 = ECCP1 outputs (P1B/P1C) are multiplexed with RH7 and RH6;					
		ECCP3 outputs (P3B/P3C) are multiplexed with RH5 and RH4					
CCDOMY	CONFIGURE						
CCP2MX	CONFIG3H	CCP2 MUX bit					
		1 = ECCP2/P2A is multiplexed with RC1					
		0 = ECCP2/P2A is multiplexed with RE7 in Microcontroller mode or with RB3 in					
		Extended Microcontroller mode (100-pin devices only)					

5.1 Device ID Word

The device ID word for the PIC18F97J60 family devices is located at 3FFFEh:3FFFFh. These readonly bits may be used by the programmer to identify what device type is being programmed and read out normally, even after Code Protection has been enabled. The process for reading the device IDs is shown in Figure 5-1. A complete list of device ID values for the PIC18F97J60 family is presented in Table 5-4.

Start

Start

Start

Set TBLPTR = 3FFFFE

Read Low Byte with Post-Increment

Read High Byte with Post-Increment

Done

TABLE 5-4: DEVICE ID VALUES

Device	Device ID Value					
Device	DEVID2	DEVID1				
PIC18F66J60	18h	000x xxxx				
PIC18F66J65	1Fh	000x xxxx				
PIC18F67J60	1Fh	001x xxxx				
PIC18F86J60	18h	001x xxxx				
PIC18F86J65	1Fh	010x xxxx				
PIC18F87J60	1Fh	011x xxxx				
PIC18F96J60	18h	010x xxxx				
PIC18F96J65	1Fh	100x xxxx				
PIC18F97J60	1Fh	101x xxxx				

Legend: The 'x's in DEVID1 are reserved for the device revision code.

5.2 Checksum Computation

The checksum is calculated by summing the contents of all code memory locations and the device Configuration Words, appropriately masked. The Least Significant 16 bits of this sum are the checksum.

The checksum calculation differs depending on whether or not code protection is enabled. Since the code memory locations read out differently depending on the code-protect setting, the table describes how to manipulate the actual code memory values to simulate

the values that would be read from a protected device. When calculating a checksum by reading a device, the entire code memory can simply be read and summed. The Configuration Words can always be read.

Table 5-5 describes how to calculate the checksum for each device.

TABLE 5-5: CHECKSUM COMPUTATION

Device	Code Protection	Checksum
PIC18F66J60	Off	SUM[000000:00FFF7] + ([00FFF8] & E1h) + ([00FFF9] & 0Ch) + ([00FFFA] & C7h) + ([00FFFB] & 0Fh) + ([00FFFD] & 04h)
	On	0000h
PIC18F66J65	Off	SUM[000000:017FF7] + ([00FFF8] & E1h) + ([00FFF9] & 0Ch) + ([00FFFA] & C7h) + ([00FFFB] & 0Fh) + ([00FFFD] & 04h)
	On	0000h
PIC18F67J60	Off	SUM[000000:01FFF7] + ([00FFF8] & E1h) + ([00FFF9] & 0Ch) + ([00FFFA] & C7h) + ([00FFFB] & 0Fh) + ([00FFFD] & 04h)
	On	0000h
PIC18F86J60	Off	SUM[000000:00FFF7] + ([017FF8] & E1h) + ([017FF9] & 0Ch) + ([017FFA] & C7h) + ([017FFB] & 0Fh) + ([017FFD] & 07h)
	On	0000h
PIC18F86J65	Off	SUM[000000:017FF7] + ([017FF8] & E1h) + ([017FF9] & 0Ch) + ([017FFA] & C7h) + ([017FFB] & 0Fh) + ([017FFD] & 07h)
	On	0000h
PIC18F87J60	Off	SUM[000000:01FFF7] + ([017FF8] & E1h) + ([017FF9] & 0Ch) + ([017FFA] & C7h) + ([017FFB] & 0Fh) + ([017FFD] & 07h)
	On	0000h
PIC18F96J60	Off	SUM[000000:00FFF7] + ([01FFF8] & E1h) + ([01FFF9] & 0Ch) + ([01FFFA] & C7h) + ([01FFFB] & 0Fh) + ([01FFFC] & F8h) + ([01FFFD] & 07h)
	On	0000h
PIC18F96J65	Off	SUM[000000:017FF7] + ([01FFF8] & E1h) + ([01FFF9] & 0Ch) + ([01FFFA] & C7h) + ([01FFFB] & 0Fh) + ([01FFFC] & F8h) + ([01FFFD] & 07h)
	On	0000h
PIC18F97J60	Off	SUM[000000:01FFF7] + ([01FFF8] & E1h) + ([01FFF9] & 0Ch) + ([01FFFA] & C7h) + ([01FFFB] & 0Fh) + ([01FFFC] & F8h) + ([01FFFD] & 07h)
	On	0000h

Legend: [a] = Value at address a; SUM[a:b] = Sum of locations a to b inclusive; + = Addition; & = Bitwise AND. All addresses are hexadecimal.

6.0 AC/DC CHARACTERISTICS AND TIMING REQUIREMENTS

TABLE 6-1: TIMING REQUIREMENTS FOR PROGRAM/VERIFY TEST MODE

Standard Operating Conditions

Operating Temperature: 25°C is recommended

Sportating reimperature. 20 G to recommended							
Param No.	Sym	Characteri	Min	Max	Units	Conditions	
	VDDCORE	External Supply Voltage for Microcontroller Core		2.35	2.70	V	(Note 1)
D111	VDD	Supply Voltage During	ENVREG = Vss	VDDCORE	3.60	V	Normal programming (Note 2)
		Programming	ENVREG = VDD	2.65	3.60		
D112	IPP	Programming Current on MCLR		_	5	μА	
D113	IDDP	Supply Current During Programming		_	10	mA	
D031	VIL	Input Low Voltage		Vss	0.2 VDD	V	
D041	VIH	Input High Voltage		0.8 VDD	Vdd	V	
D080	Vol	Output Low Voltage		_	0.4	V	IOL = 8 mA @ 3.3V
D090	Vон	Output High Voltage	2.4	_	V	IOH = -8 mA @ 3.3V	
D012	Сю	Capacitive Loading on I/O pin (PGD)		_	50	pF	To meet AC specifications
	Cf	Filter Capacitor Value on	1	_	μF	Required for controller core operation when voltage regulator is enabled	

Note 1: VDDCORE must be supplied to the VDDCORE/VCAP pin if the on-chip voltage regulator is disabled. See Section 2.1.1 "On-Chip Voltage Regulator" for more information.

^{2:} VDD must also be supplied to the AVDD pins during programming and to the ENVREG if the on-chip voltage regulator is used. AVDD and AVSS should always be within ±0.3V of VDD and VSS, respectively.

TABLE 6-1: TIMING REQUIREMENTS FOR PROGRAM/VERIFY TEST MODE (CONTINUED)

Standard Operating Conditions

Operating Temperature: 25°C is recommended

'									
Param No.	Sym	Characteristic	Min	Max	Units	Conditions			
P2	TPGC	Serial Clock (PGC) Period	100	-	ns				
P2A	TPGCL	Serial Clock (PGC) Low Time	40	_	ns				
P2B	TPGCH	Serial Clock (PGC) High Time	40	_	ns				
P3	TSET1	Input Data Setup Time to Serial Clock ↓	15	_	ns				
P4	THLD1	Input Data Hold Time from PGC ↓	15	_	ns				
P5	TDLY1	Delay between 4-bit Command and Command Operand	40	_	ns				
P5A	TDLY1A	Delay between 4-bit Command Operand and Next 4-bit Command	40	_	ns				
P6	TDLY2	Delay between Last PGC ↓ of Command Byte to First PGC ↑ of Read of Data Word	20	_	ns				
P9	TDLY5	Delay to allow Block Programming to Occur	3.4	_	ms				
P10	TDLY6	Delay to allow Row Erase to Occur	49	_	ms				
P11	TDLY7	Delay to allow Bulk Erase to Occur	475	_	ms				
P12	THLD2	Input Data Hold Time from MCLR ↑	400	_	μS				
P13	TSET2	VDD ↑ Setup Time to MCLR ↑	100	_	ns				
P14	TVALID	Data Out Valid from PGC ↑	10	_	ns				
P16	TDLY8	Delay between Last PGC ↓ and MCLR ↓	20	_	ns				
P19	TKEY1	Delay from First MCLR ↓ to First PGC ↑ for Key Sequence on PGD	1	_	ms				
P20	TKEY2	Delay from Last PGC ↓ for Key Sequence on PGD to Second MCLR ↑	40	_	ns				

Note 1: VDDCORE must be supplied to the VDDCORE/VCAP pin if the on-chip voltage regulator is disabled. See Section 2.1.1 "On-Chip Voltage Regulator" for more information.

^{2:} VDD must also be supplied to the AVDD pins during programming and to the ENVREG if the on-chip voltage regulator is used. AVDD and AVSs should always be within ±0.3V of VDD and Vss, respectively.

Note the following details of the code protection feature on Microchip devices:

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